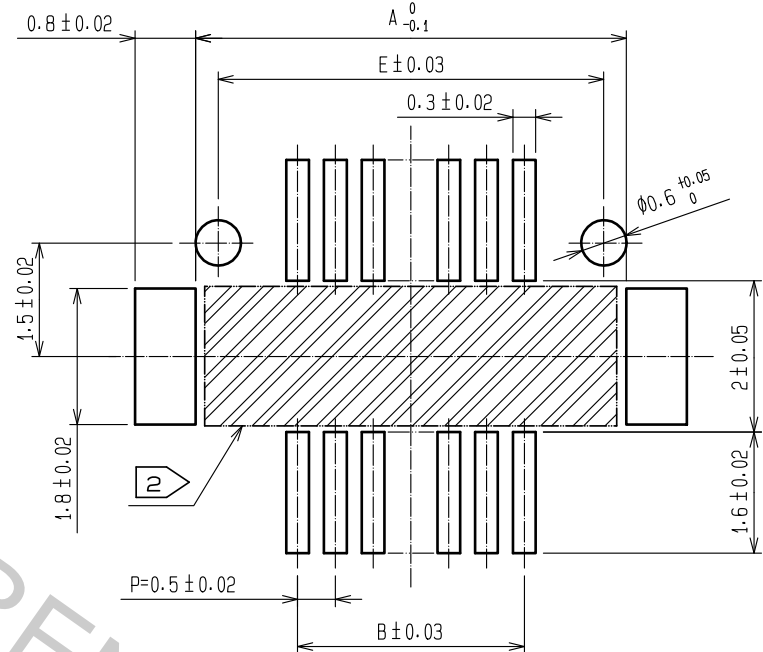
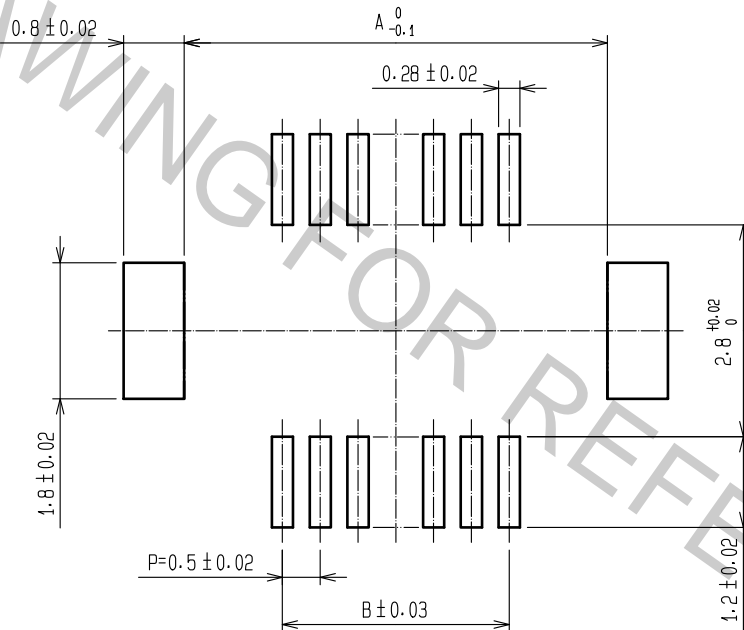
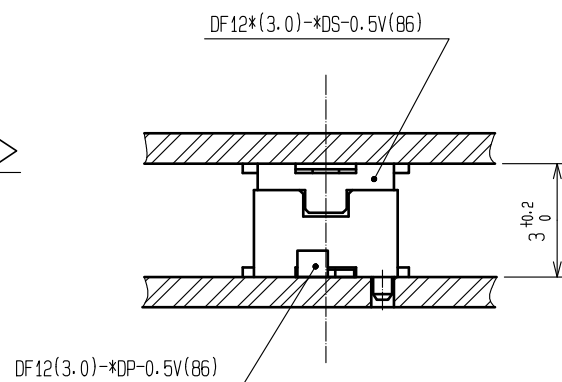
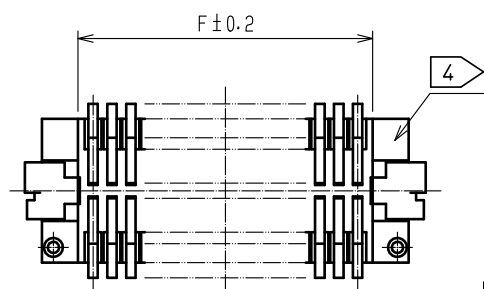
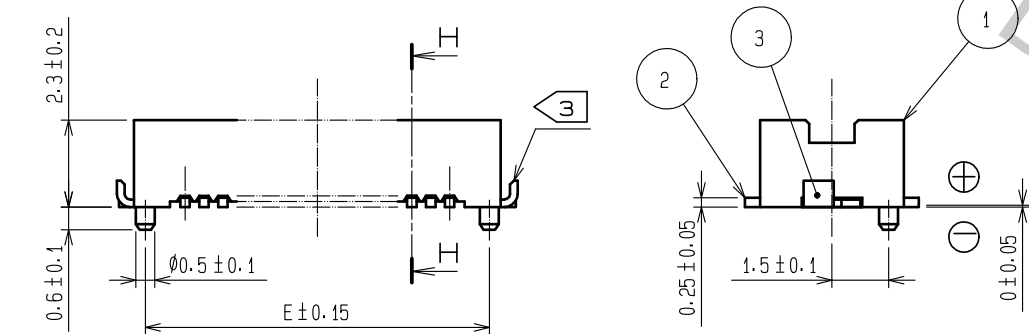
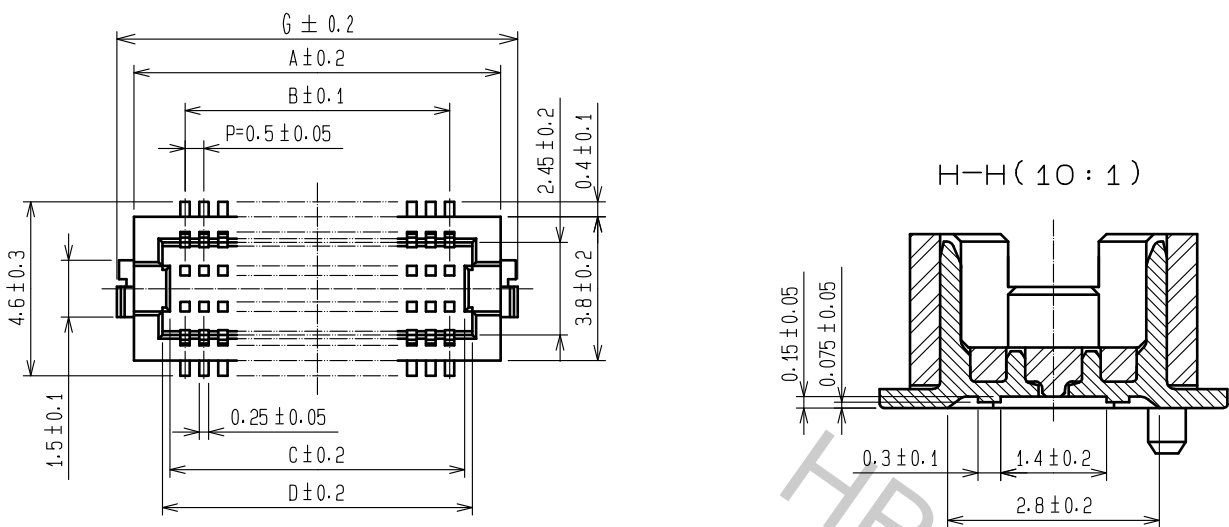

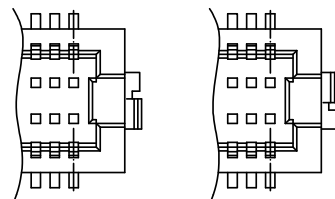


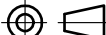


CODE No.	CONTACT	A	B	C	D	E	F	G
CL537-0721-0-86	10	4.7	2.0	2.8	3.2	4.1	2.8	5.6
CL537-0918-4-86	14	5.7	3.0	3.8	4.2	5.1	3.8	6.6
CL537-0723-5-86	20	7.2	4.5	5.3	5.7	6.6	5.3	8.1
CL537-0725-0-86	30	9.7	7.0	7.8	8.2	9.1	7.8	10.6
CL537-0732-6-86	32	10.2	7.5	8.3	8.7	9.6	8.3	11.1
CL537-0726-3-86	36	11.2	8.5	9.3	9.7	10.6	9.3	12.1
CL537-0727-6-86	40	12.2	9.5	10.3	10.7	11.6	10.3	13.1
CL537-0729-1-86	50	14.7	12.0	12.8	13.2	14.1	12.8	15.6
CL537-0731-3-86	60	17.2	14.5	15.3	15.7	16.6	15.3	18.1
CL537-0733-9-86	80	22.2	19.5	20.3	20.7	21.6	20.3	23.1




RECOMMENDED THICKNESS OF
SOLDER PASTE : 120 μm

- NOTES 1 LEAD CO-PLANARITY SHALL BE 0.08 mm MAX.
 2 IF THERE IS PATTERN ON  PART, THERE IS A POSSIBILITY THAT IT WILL MAKE CONTACT WITH THE LEADS.
 3 REINFORCED METAL FITTINGS AS FOLLOWS.
 4 CAV NO. ARE INDICATED IN APPROXIMAL POSITION SHOWN.



2	PHOSPHOR BRONZE	CONTACT AREA:GOLD PLATED 0.2μm min		5	POLYESTER	CLEAR (COVER TAPE)				
		LEAD AREA:GOLD PLATED 0.015μm min		4	PS	CLEAR (EMBOSSSED CARRIER TAPE)				
		OTHERS(UNDER PLATING):NICKEL PLATED 2μm min		3	BRASS	TIN PLATED 2μm min (UNDER PLATING):NICKEL 1μm min				
1	POLYAMIDE	UL94V-0・NATURAL (BEIGE)								
NO.	MATERIAL	FINISH , REMARKS			NO.	MATERIAL	FINISH , REMARKS			
UNITS mm		SCALE 5 : 1		COUNT	DESCRIPTION OF REVISIONS		DESIGNED		CHECKED	DATE
				2	DIS-H-00002907		SH. HOSODA		TS. MIYAZAKI	17. 06. 07
				APPROVED : KH. IKEDA 11. 11. 17		DRAWING NO. EDC3-163507-77				
				CHECED : TS. MIYAZAKI 11. 11. 17		PART NO. DF12(3.0)-*DP-0.5V(86)				
				DESIGNED : YH. MICHIDA 11. 11. 17		CODE NO. CL537				
DRAWN : KR. AJITO 11. 11. 17								 1/2		

 HIROSE ELECTRIC CO., LTD.

